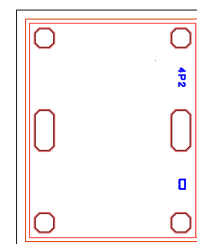


MMIC

Power Splitter/Combiner Die

WP4P1-D+

4 Way-0° 50Ω 1525 to 2375 MHz



The Big Deal

- Wide Bandwidth, 1525 to 2375 MHz
- Excellent Amplitude Unbalance, 0.15 dB typ.

Product Overview

Mini-Circuits' WP4P1-D+ is a MMIC 4-way 0° splitter/combiner Die designed for wideband operation from 1525 to 2375 MHz. Manufactured using Si IPD technology, its compact size saves valuable space in hybrids.

Key Features

Feature	Advantages
Bandwidth, 1525 to 2375 MHz	One power splitter can be used in many applications, saving component count.
Excellent Amplitude Unbalance, 0.15 dB typ. and Good Phase Unbalance, 1 deg. typ.	Excellent Amplitude and phase unbalance helps to accurately divide the input signals which is essential in test and measurement circuits.
Unpackaged Die, 0.855 x 1.069 mm	Enables user to integrate it directly into hybrids. Small die size saves space in customer hybrids.



MMIC

Power Splitter/Combiner Die

WP4P1-D+

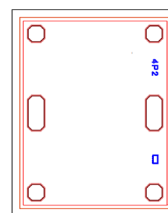
4 Way-0° 50Ω 1525 to 2375 MHz

Product Features

- Wide bandwidth, 1525 to 2375 MHz
- Excellent amplitude unbalance, 0.15 dB typ.

Applications

- PCS/DCS
- WCDMA
- GPS



+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Ordering Information: Refer to Last Page

General Description

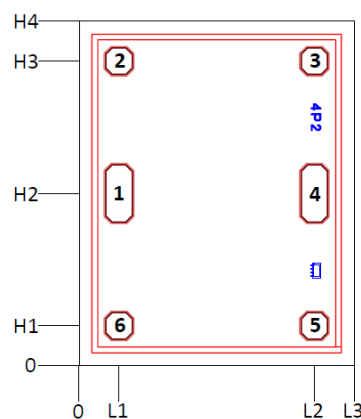
Mini-Circuits' WP4P1-D+ is a MMIC 4-way 0° splitter/combiner Die designed for wideband operation from 1525 to 2375 MHz. Manufactured using Si IPD technology, its compact size saves valuable space in hybrids.

Simplified Schematic and Pad Description



Pad#	Function
1	RF IN
2	RF OUT 1
3	RF OUT 2
5	RF OUT 3
6	RF OUT 4
4	Ground

Bonding Pad Position



Dimensions in μm , Typical

L1	L2	L3	H1	H2	H3	H4	Thickness	Die Size	Pad Size 1 & 4	Pad Size 2,3,5 & 6
124	731	855	124	534	945	1069	254	855x1069	82 x 177	82 x 82



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Electrical Specifications at 25°C¹

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		1525		2375	MHz
Insertion Loss above 3.0 dB	1525 - 2375		0.9		dB
Isolation	1525 - 2375		26		dB
Phase Unbalance	1525 - 2375		2.0		Degree
Amplitude Unbalance	1525 - 2375		0.2		dB
VSWR (Port S)	1525 - 2375		1.5		:1
VSWR (Port 1,2,3,4)	1525 - 2375		1.4		:1

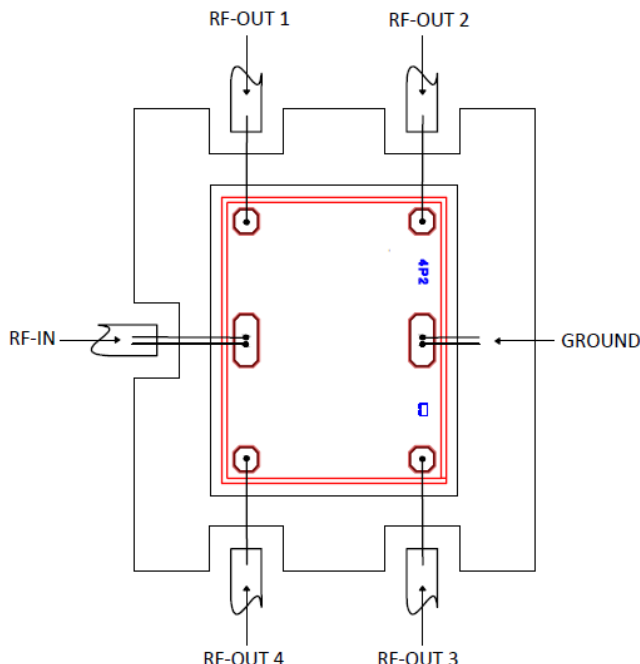
1. Tested in 3x3mm, Mini-Circuits 12-lead MCLP package.

Maximum Ratings^{1,2}

Parameter	Ratings
Operating Temperature	-40°C to 85°C
Power Input (as a splitter)	1.5W
Internal Dissipation	0.375W

2. Permanent damage may occur if any of these limits are exceeded.

Assembly Diagram



Assembly and Handling Procedure

1. Storage
Dice should be stored in a dry nitrogen purged desiccators or equivalent.
2. ESD
MMIC dice are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic protected material, which should be opened in clean room conditions at an appropriately grounded anti-static workstation. Devices need careful handling using correctly designed collets, vacuum pickup tips or sharp antistatic tweezers to deter ESD damage to dice.
3. Die Attach
The Die mounting surface must be clean and flat. Using conductive silver filled epoxy, recommended epoxies are DieMat DM6030HK-PT/H579 or Ablestik 84-1LMISR4. Apply sufficient epoxy to meet required epoxy bond line thickness, epoxy fillet height and epoxy coverage around total Die periphery. Parts shall be cured in a nitrogen filled atmosphere per manufacturer's cure condition. It is recommended to use antistatic Die pick up tools only.
4. Wire Bonding
Bond pad openings in the surface passivation above the bond pads are provided to allow wire bonding to the dice gold bond pads. Thermosonic bonding is used with minimized ultrasonic content. Bond force, time, ultrasonic power and temperature are all critical parameters. Suggested wire is pure gold, 1 mil diameter. Bonds must be made from the bond pads on the Die to the package or substrate. All bond wires should be kept as short as low as reasonable to minimize performance degradation due to undesirable series inductance.

additional information is available on our dash board.

*Known Good Dice ("KGD") means that the dice are taken from PCM good wafer and visually inspected in question have been subjected to Mini-Circuits while this is not definitive, it does help to provide a higher degree of confidence that dice are capable of meeting typical RF electrical parameters specified by Mini-Circuits.

Human Body Model (HBM): Class 1A (Pass 250V) in accordance with ANSI/ESD STM 5.1 - 2001

** Tested in 3x3mm. Mini-Circuits 12-lead MCLP package.

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4 Way-0° Power Splitter/Combiner Die

WP4P1-D+

Typical Performance Data

TEST CONDITIONS: INPUT POWER = -10dBm @ Temperature = +25°C

FREQ. (MHz)	TOTAL LOSS ¹				AMP. UNBAL. (dB)	ISOLATION			PHASE UNBAL. (deg.)	FREQ. (MHz)	VSWR				
	S-1	S-2	S-3	S-4		1-2	2-3	3-4			S	1	2	3	4
1200	9.98	10.24	10.15	9.95	0.29	17.01	15.25	16.97	3.76	1200	4.82	1.76	1.69	1.70	1.68
1300	8.85	9.09	9.00	8.82	0.27	18.94	16.81	18.87	3.22	1300	3.51	1.70	1.64	1.65	1.63
1400	7.99	8.21	8.12	7.97	0.25	21.67	18.89	21.52	2.75	1400	2.61	1.63	1.59	1.60	1.57
1500	7.38	7.58	7.49	7.35	0.23	25.63	21.61	25.36	2.30	1500	2.00	1.56	1.53	1.53	1.52
1525	7.26	7.46	7.37	7.23	0.22	26.91	22.40	26.61	2.19	1525	1.88	1.55	1.51	1.52	1.50
1575	7.07	7.25	7.16	7.04	0.21	29.98	24.11	29.61	1.98	1575	1.68	1.52	1.48	1.49	1.48
1600	6.98	7.16	7.08	6.95	0.21	31.75	25.01	31.40	1.88	1600	1.58	1.50	1.47	1.48	1.47
1650	6.85	7.01	6.93	6.82	0.20	34.91	26.76	35.09	1.69	1650	1.42	1.48	1.44	1.45	1.44
1675	6.80	6.95	6.87	6.76	0.19	35.19	27.49	35.99	1.60	1675	1.36	1.47	1.43	1.44	1.43
1710	6.73	6.89	6.80	6.70	0.19	33.76	28.19	34.96	1.49	1710	1.27	1.45	1.41	1.42	1.41
1720	6.72	6.87	6.79	6.68	0.18	33.16	28.30	34.34	1.46	1720	1.25	1.45	1.41	1.42	1.41
1740	6.69	6.84	6.76	6.66	0.18	31.91	28.38	33.00	1.39	1740	1.22	1.44	1.40	1.41	1.40
1760	6.67	6.81	6.73	6.63	0.18	30.71	28.28	31.68	1.33	1760	1.18	1.43	1.39	1.40	1.39
1780	6.65	6.79	6.71	6.62	0.17	29.60	28.02	30.45	1.27	1780	1.16	1.43	1.38	1.39	1.39
1800	6.64	6.77	6.69	6.60	0.17	28.61	27.64	29.36	1.21	1800	1.14	1.42	1.38	1.38	1.38
1820	6.62	6.75	6.67	6.59	0.16	27.72	27.17	28.38	1.15	1820	1.13	1.42	1.37	1.38	1.37
1840	6.62	6.74	6.66	6.58	0.16	26.92	26.66	27.50	1.09	1840	1.13	1.41	1.36	1.37	1.37
1860	6.61	6.73	6.65	6.58	0.16	26.20	26.13	26.72	1.03	1860	1.14	1.41	1.36	1.36	1.36
1880	6.61	6.73	6.65	6.57	0.15	25.54	25.59	26.01	0.97	1880	1.16	1.40	1.35	1.36	1.35
1900	6.61	6.72	6.64	6.57	0.15	24.95	25.06	25.36	0.91	1900	1.18	1.40	1.34	1.35	1.35
1920	6.61	6.72	6.64	6.58	0.15	24.40	24.55	24.78	0.86	1920	1.21	1.40	1.34	1.35	1.34
1940	6.61	6.72	6.64	6.58	0.14	23.91	24.08	24.25	0.80	1940	1.24	1.40	1.34	1.34	1.34
1960	6.62	6.72	6.64	6.58	0.14	23.45	23.62	23.76	0.75	1960	1.27	1.39	1.33	1.34	1.33
1980	6.63	6.73	6.64	6.59	0.13	23.03	23.19	23.31	0.69	1980	1.30	1.39	1.33	1.33	1.33
2000	6.63	6.73	6.65	6.60	0.13	22.64	22.77	22.89	0.64	2000	1.33	1.39	1.32	1.33	1.32
2025	6.65	6.74	6.66	6.61	0.12	22.19	22.29	22.40	0.63	2025	1.37	1.39	1.32	1.32	1.32
2050	6.66	6.75	6.67	6.63	0.12	21.79	21.84	21.97	0.64	2050	1.41	1.39	1.31	1.32	1.32
2100	6.70	6.77	6.69	6.66	0.11	21.07	21.03	21.19	0.65	2100	1.49	1.39	1.31	1.31	1.31
2150	6.74	6.80	6.72	6.71	0.10	20.47	20.32	20.53	0.72	2150	1.57	1.39	1.30	1.31	1.30
2200	6.78	6.84	6.75	6.75	0.09	19.94	19.70	19.97	0.85	2200	1.65	1.39	1.30	1.30	1.30
2250	6.83	6.88	6.79	6.80	0.09	19.50	19.15	19.48	0.98	2250	1.73	1.39	1.30	1.30	1.30
2300	6.88	6.92	6.83	6.85	0.09	19.12	18.67	19.06	1.10	2300	1.80	1.39	1.30	1.30	1.30
2350	6.93	6.96	6.87	6.90	0.09	18.78	18.23	18.69	1.24	2350	1.88	1.40	1.30	1.30	1.29
2375	6.96	6.98	6.89	6.93	0.10	18.63	18.02	18.52	1.32	2375	1.92	1.40	1.29	1.30	1.29
2400	6.99	7.01	6.91	6.95	0.10	18.50	17.83	18.36	1.40	2400	1.95	1.40	1.29	1.30	1.29
2500	7.09	7.10	6.99	7.06	0.11	18.01	17.15	17.82	1.72	2500	2.09	1.41	1.30	1.29	1.29
2600	7.20	7.19	7.08	7.17	0.13	17.63	16.56	17.39	2.03	2600	2.24	1.41	1.30	1.29	1.29
2700	7.32	7.29	7.17	7.27	0.15	17.32	16.05	17.07	2.34	2700	2.37	1.41	1.29	1.29	1.29
2800	7.42	7.37	7.25	7.37	0.18	17.06	15.60	16.81	2.65	2800	2.48	1.42	1.29	1.28	1.29
3000	7.64	7.54	7.41	7.56	0.22	16.63	14.79	16.42	3.24	3000	2.71	1.41	1.28	1.27	1.28
3200	7.83	7.69	7.56	7.73	0.27	16.28	14.07	16.14	3.75	3200	2.91	1.39	1.26	1.25	1.26
3400	8.00	7.82	7.70	7.88	0.30	15.95	13.39	15.89	4.25	3400	3.07	1.37	1.24	1.23	1.24
3600	8.17	7.96	7.84	8.03	0.34	15.59	12.75	15.61	4.65	3600	3.24	1.35	1.22	1.21	1.23
3800	8.34	8.10	7.97	8.17	0.37	15.21	12.15	15.26	5.11	3800	3.42	1.33	1.21	1.21	1.23
4000	8.50	8.27	8.12	8.32	0.39	14.78	11.60	14.81	5.63	4000	3.62	1.32	1.22	1.22	1.25
4200	8.65	8.42	8.24	8.45	0.41	14.27	11.12	14.26	6.27	4200	3.80	1.32	1.26	1.25	1.28
4400	8.76	8.55	8.36	8.59	0.41	13.65	10.71	13.57	7.00	4400	3.94	1.33	1.32	1.30	1.33
4600	8.86	8.67	8.47	8.66	0.39	12.90	10.36	12.82	7.74	4600	4.10	1.37	1.42	1.38	1.42
4800	8.92	8.77	8.56	8.73	0.36	12.12	10.11	12.04	8.40	4800	4.22	1.42	1.54	1.47	1.52
5000	8.94	8.82	8.64	8.73	0.30	11.33	9.98	11.27	8.96	5000	4.28	1.49	1.67	1.60	1.65
5200	8.91	8.86	8.70	8.73	0.21	10.61	9.97	10.55	9.35	5200	4.29	1.58	1.82	1.75	1.82
5400	8.89	8.94	8.78	8.74	0.20	9.97	10.05	9.90	9.55	5400	4.34	1.68	1.99	1.92	1.99
5600	8.88	9.02	8.85	8.73	0.29	9.41	10.16	9.32	9.81	5600	4.39	1.79	2.15	2.09	2.17
5800	8.86	9.13	8.93	8.77	0.37	8.93	10.25	8.82	10.22	5800	4.45	1.88	2.29	2.24	2.34

¹Total Loss = Insertion Loss + 6dB Splitter Loss

Note: Test data of Die packaged in industry standard, 3x3 mm, 12-lead MCLP package



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The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com



IF/RF MICROWAVE COMPONENTS

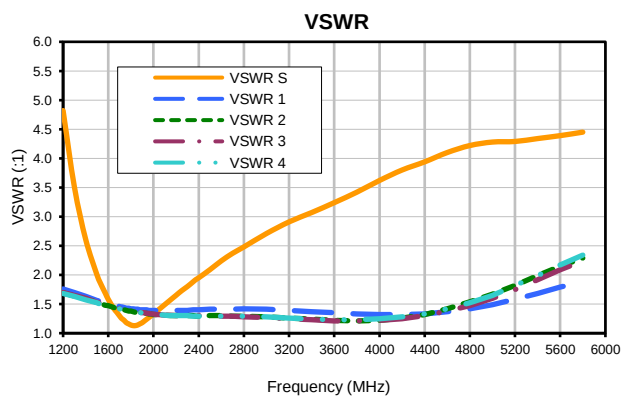
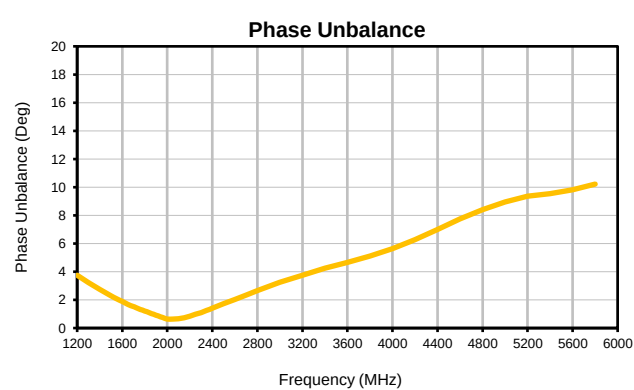
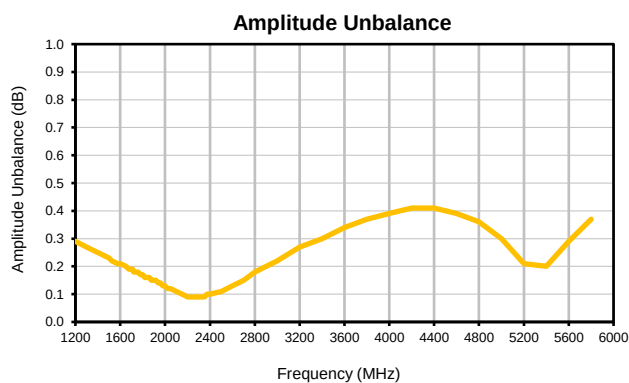
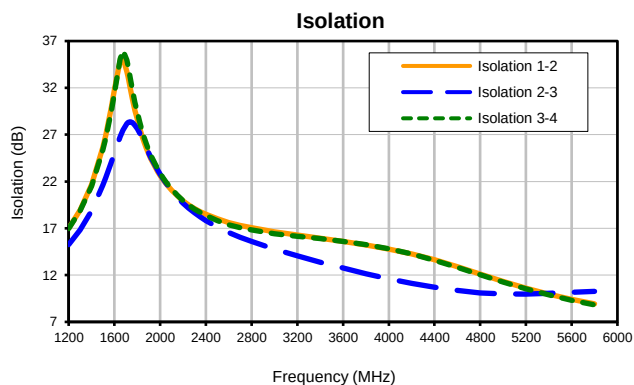
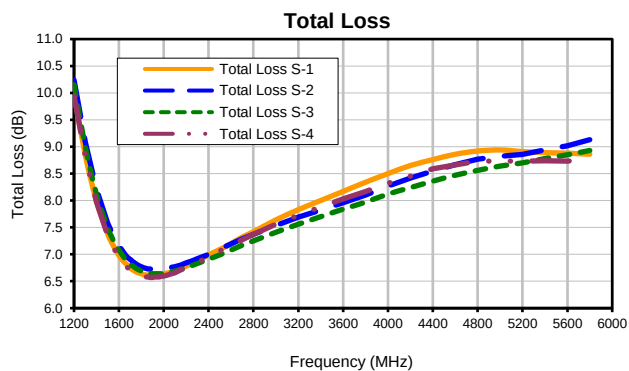


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4 Way-0° Power Splitter/Combiner Die

WP4P1-D+

Typical Performance Curves



Note: Test data of Die packaged in industry standard, 3x3 mm, 12-lead MCLP package



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IF/RF MICROWAVE COMPONENTS



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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C or -40° to 105° C or -55° to 105° C Ambient Environment	Refer to Individual Model Data Sheet
Storage Environment	20° to 35° C and 40 to 60% humidity (In Factory Shipped Package)	Individual Model Data Sheet